CERAMIC

Power Splitter/Combiner SCG-2-722+

2 Way-0° 50Ω 4.2 to 7.2 GHz

THE BIG DEAL

- Industry leading combination of size/power handling
- Rugged, ceramic construction
- Good power handling, 2W

Generic photo used for illustration purposes only

CASE STYLE: GE0805C-1

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- 5G SUB 6Hz
- WIFI 6

PRODUCT OVERVIEW

Mini-Circuits new LTCC 0° Power Splitter, model SCG-2-722+, offers industry leading combination of operating performance and size. The outstanding phase and amplitude unbalance make this component a versatile building block for use in a variety of systems and sub-system designs.

KEY FEATURES

Feature	Advantages
LTCC Construction	Provides repeatable performance in a rugged, ceramic package well suited for tough environments such as high humidity and temperature extremes.
Good power handling, 2W	Supports a wide range of system power requirements.
Wrap-around terminations	Provides excellent solderability and easy visual inspection
Wide band Performance	Operate from 4.2 to 7.2 GHz to cover multiple telecom applications

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ELECTRICAL SPECIFICATIONS AT 25°C

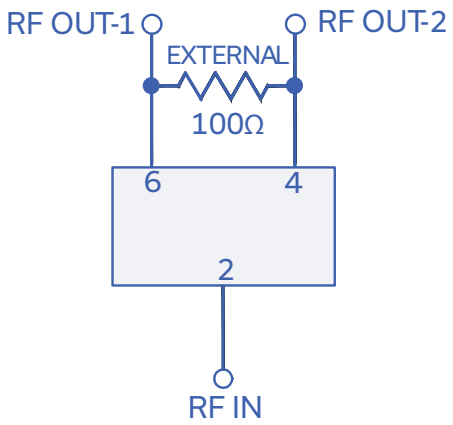
Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		4200		7200	MHz
Insertion Loss, above 3.0 dB	4200-6400 6400-7200		0.9 1.7	1.3	dB
Isolation	4200-7200	10	13		dB
Phase Unbalance	4200-6400 6400-7200		2 3	6 9	Degree
Amplitude Unbalance	4200-7200		0.2	0.5	dB
Return Loss (Input)	4200-6400 6400-7200	8.5	12 7.5		dB
Return Loss (Output)	4200-6400 6400-7200	11	16 9		dB

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
Power Input (as a splitter)	2W* max.

* Derate linearly to 0.7W at 100°C ambient, power input as combiner is limited by rating of external resistor 100Ω resistor.
Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



CERAMIC

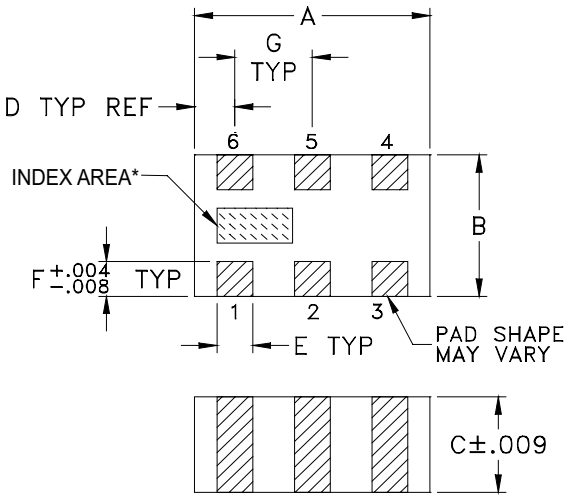
Power Splitter/Combiner SCG-2-722+

2 Way-0° 50Ω 4.2 to 7.2 GHz

PAD CONNECTIONS

SUM PORT	2
PORT 1	6
PORT 2	4
GROUND	1,3,5
PORT 1-2	resistor external 100 ohms

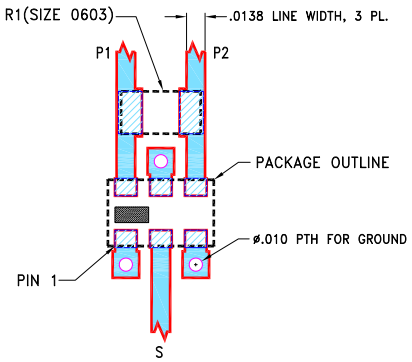
OUTLINE DRAWING



*Shape of index marking may vary

PRODUCT MARKING: SK

DEMO BOARD MCL P/N: TB-1043+
SUGGESTED PCB LAYOUT (PL-560)



NOTES:
1. LINE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS LINE WIDTH MAY NEED TO BE MODIFIED.
2. UNIT FOOT PRINT IS OPTIMIZED FOR PERFORMANCE AND IS DIFFERENT FROM CASE STYLE GE0805C−1 RECOMMENDATIONS.
3. CHIP COMPONENT FOOT PRINT IS SHOWN FOR REFERENCE. FOR COMPONENT VALUE REFER TO TB−1043+.
4. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F	G	wt
.079	.049	.033	.014	.012	.012	.026	grams
2.01	1.24	0.84	0.36	0.30	0.30	0.65	.008

TAPE & REEL INFORMATION: F74

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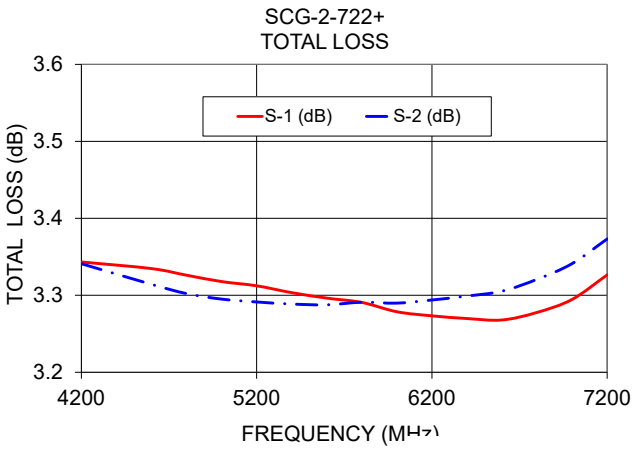
Power Splitter/Combiner SCG-2-722+

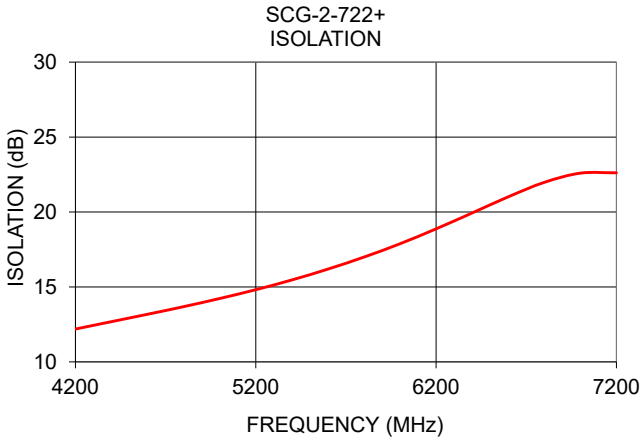
2 Way-0° 50Ω 4.2 to 7.2 GHz

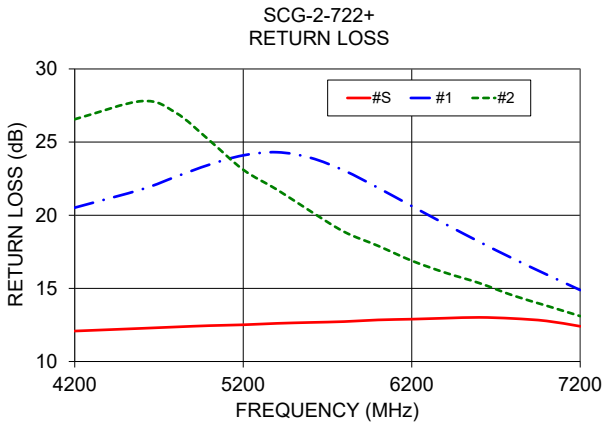
TYPICAL PERFORMANCE DATA

Frequency (MHz)	Total Loss[1] (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	Return Loss (dB)		
	S-1	S-2				S	1	2
4200	3.34	3.34	0.00	12.19	2.79	12.08	20.52	26.56
4600	3.33	3.31	0.02	13.18	2.77	12.27	21.78	27.80
4800	3.33	3.30	0.02	13.68	2.78	12.36	22.63	27.01
5000	3.32	3.30	0.02	14.23	2.77	12.45	23.46	25.11
5200	3.31	3.29	0.02	14.82	2.78	12.51	24.09	23.11
5400	3.30	3.29	0.01	15.47	2.82	12.61	24.31	21.75
5600	3.30	3.29	0.01	16.19	2.85	12.67	23.92	20.27
5800	3.29	3.29	0.00	16.99	2.91	12.73	23.05	18.86
6000	3.28	3.29	0.01	17.88	2.99	12.84	21.88	17.91
6200	3.27	3.29	0.02	18.88	3.10	12.89	20.62	16.89
6400	3.27	3.30	0.03	19.94	3.20	12.96	19.39	16.07
6600	3.27	3.31	0.04	21.01	3.34	13.02	18.19	15.37
6800	3.28	3.32	0.04	21.98	3.49	12.94	17.04	14.52
7000	3.29	3.34	0.05	22.59	3.63	12.77	15.95	13.81
7200	3.33	3.37	0.05	22.61	3.80	12.41	14.88	13.10

1. Total Loss = Insertion Loss + 3dB splitter loss.







NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

2 Way-0° Power Splitter/Combiner SCG-2-272+

Typical Performance Data

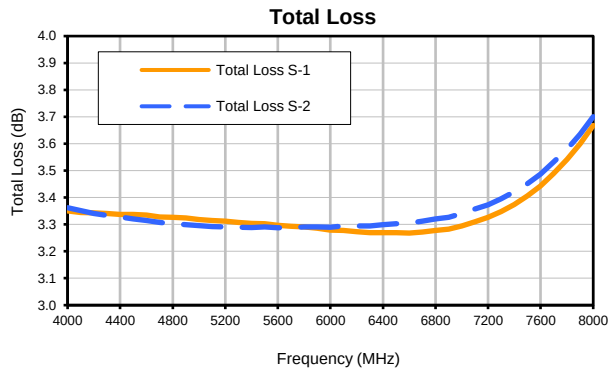
FREQUENCY (MHz)	TOTAL LOSS[1] (dB)		AMPLITUDE UNBALANCE (dB)	ISOLATION (dB)	PHASE UNBALANCE (deg.)
	S-1	S-2		1-2	
4000	3.35	3.36	0.01	11.70	2.75
4100	3.34	3.35	0.01	11.95	2.77
4200	3.34	3.34	0.00	12.19	2.79
4300	3.34	3.33	0.01	12.44	2.77
4400	3.34	3.33	0.01	12.68	2.78
4500	3.34	3.32	0.02	12.93	2.79
4600	3.33	3.31	0.02	13.18	2.77
4700	3.33	3.31	0.02	13.43	2.77
4800	3.33	3.30	0.02	13.68	2.78
4900	3.32	3.30	0.02	13.95	2.77
5000	3.32	3.30	0.02	14.23	2.77
5100	3.31	3.29	0.02	14.52	2.78
5200	3.31	3.29	0.02	14.82	2.78
5300	3.31	3.29	0.02	15.14	2.79
5400	3.30	3.29	0.01	15.47	2.82
5500	3.30	3.29	0.01	15.82	2.83
5600	3.30	3.29	0.01	16.19	2.85
5700	3.29	3.29	0.00	16.58	2.88
5800	3.29	3.29	0.00	16.99	2.91
5900	3.29	3.29	0.01	17.43	2.95
6000	3.28	3.29	0.01	17.88	2.99
6100	3.28	3.29	0.02	18.37	3.04
6200	3.27	3.29	0.02	18.88	3.10
6300	3.27	3.29	0.02	19.40	3.14
6400	3.27	3.30	0.03	19.94	3.20
6500	3.27	3.30	0.03	20.48	3.27
6600	3.27	3.31	0.04	21.01	3.34
6700	3.27	3.31	0.04	21.54	3.40
6800	3.28	3.32	0.04	21.98	3.49
6900	3.28	3.33	0.04	22.35	3.56
7000	3.29	3.34	0.05	22.59	3.63
7100	3.31	3.36	0.05	22.69	3.72
7200	3.33	3.37	0.05	22.61	3.80
7300	3.35	3.40	0.05	22.41	3.87
7400	3.37	3.42	0.05	22.06	3.97
7500	3.41	3.45	0.05	21.62	4.05
7600	3.44	3.49	0.04	21.10	4.12
7700	3.49	3.53	0.04	20.56	4.20
7800	3.54	3.58	0.04	20.01	4.30
7900	3.60	3.64	0.04	19.43	4.36
8000	3.67	3.70	0.03	18.91	4.45

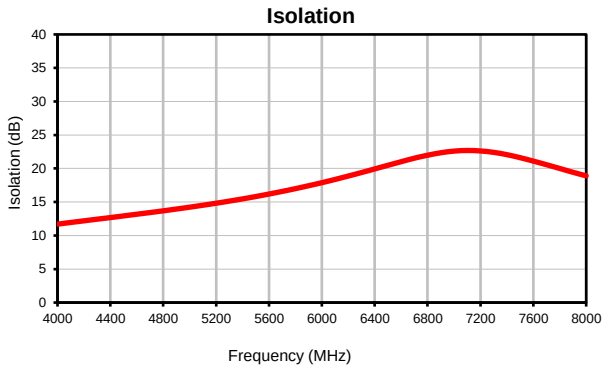
FREQUENCY (MHz)	VSWR (:1)		
	S	1	2
4000	1.68	1.22	1.12
4100	1.67	1.21	1.11
4200	1.66	1.21	1.10
4300	1.66	1.20	1.09
4400	1.65	1.19	1.09
4500	1.65	1.19	1.08
4600	1.64	1.18	1.08
4700	1.64	1.17	1.09
4800	1.63	1.16	1.09
4900	1.63	1.15	1.11
5000	1.63	1.14	1.12
5100	1.62	1.14	1.13
5200	1.62	1.13	1.15
5300	1.62	1.13	1.16
5400	1.61	1.13	1.18
5500	1.61	1.13	1.20
5600	1.61	1.14	1.21
5700	1.60	1.14	1.23
5800	1.60	1.15	1.26
5900	1.60	1.16	1.27
6000	1.59	1.18	1.29
6100	1.59	1.19	1.32
6200	1.59	1.21	1.33
6300	1.58	1.22	1.35
6400	1.58	1.24	1.37
6500	1.58	1.26	1.39
6600	1.58	1.28	1.41
6700	1.58	1.30	1.44
6800	1.58	1.33	1.46
6900	1.59	1.35	1.48
7000	1.60	1.38	1.51
7100	1.61	1.41	1.55
7200	1.63	1.44	1.57
7300	1.66	1.47	1.60
7400	1.69	1.51	1.64
7500	1.72	1.55	1.67
7600	1.77	1.59	1.71
7700	1.83	1.64	1.76
7800	1.89	1.69	1.80
7900	1.96	1.74	1.85
8000	2.05	1.80	1.91

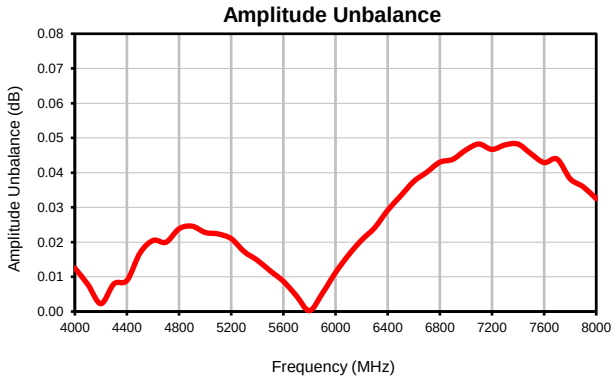
[1]Total Loss = Insertion Loss + 3dB Splitter Loss

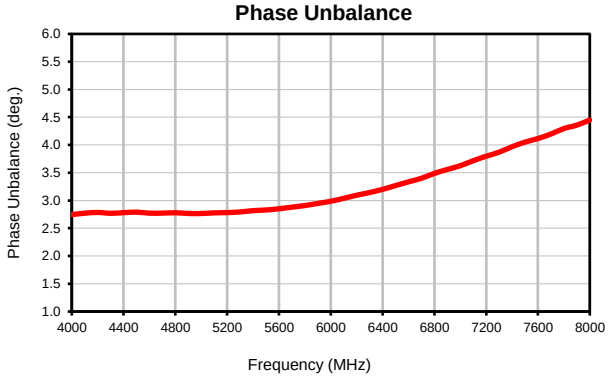
2 Way-0° Power Splitter/Combiner SCG-2-272+

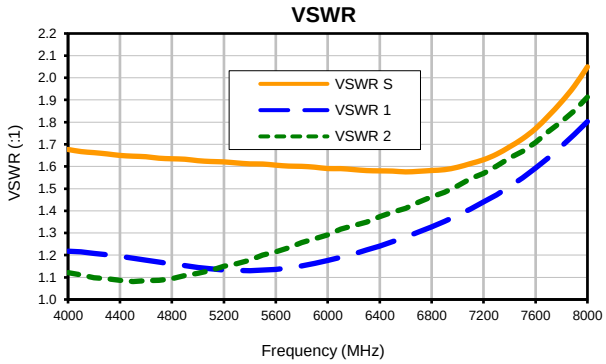
Typical Performance Curves





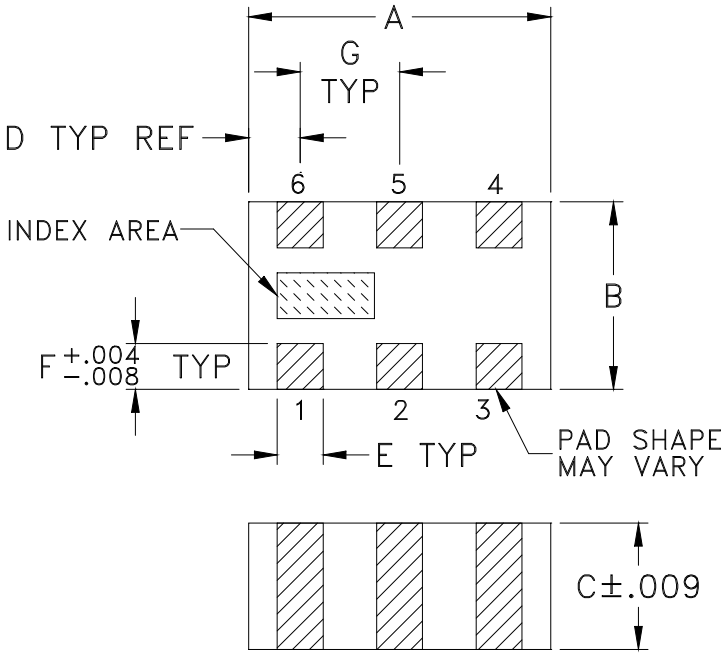




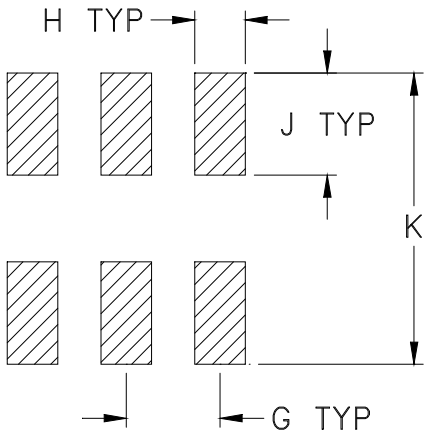


GE0805C-1

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
GE0805C-1	.079 (2.00)	.049 (1.25)	.033 (0.84)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Style: Tin-lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F74

DEVICE ORIENTATION IN T&R

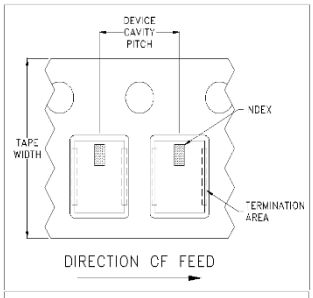


ILLUSTRATION 1

Applicable Case Styles
GE0805C-1
GE0805C-1AP
JV1210C-1
GU2939

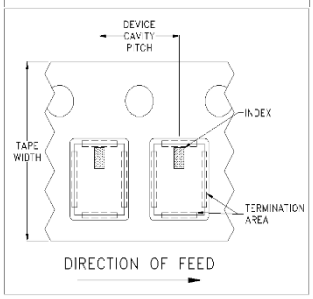


ILLUSTRATION 2

Applicable Case Styles
JV1210C
JV1210C-2
JV1210C-3
JV1210C-4
JV1210C-5
JV1210C-6
JV1210C-11

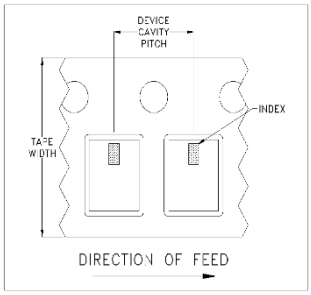


ILLUSTRATION 3

Applicable Case Styles
JC0603C-8
JC0603C-9
JV1210C-7
JV1210C-8
JV1210C-9
JV1210C-10
JV1210C-13
GE0805C-13
GE0805C-19
GE0805C-20

Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel	
8	4	7	Small quantity standards **(see note)**	20
				50
				100
				200
				500
				1000
			Standard	2000
				4000

Note: Small reel availability varies by model. Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.
Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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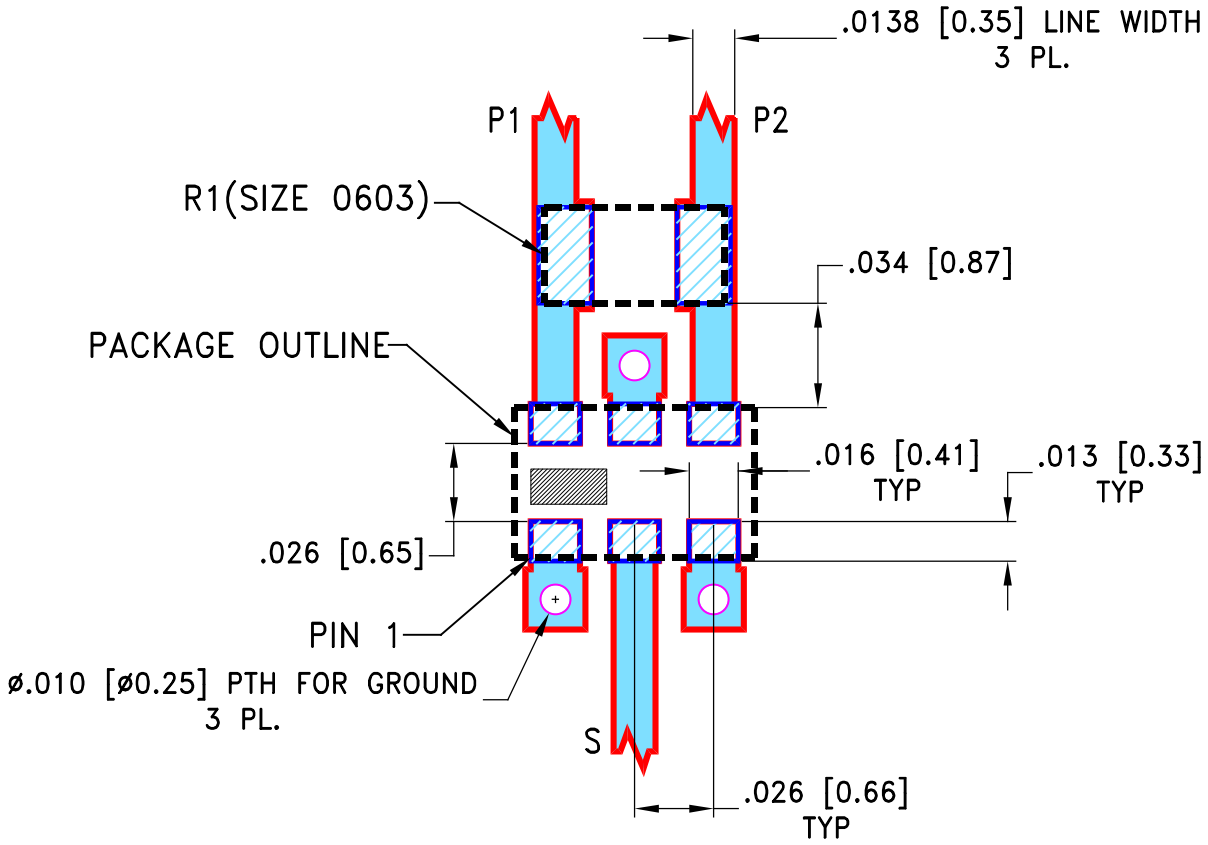
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M172101	NEW RELEASE	02/20/19	ITG	SL
A	ECO-004368	ADDED DIMENSIONS IN [MM]		GF	

SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-1 CASE STYLE, "06SP17" PIN CODE



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4. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES[MM]	DRAWN	ITG	01/21/19
TOLERANCES ON:	CHECKED	GF	01/22/19
2 PL DECIMALS ±	APPROVED	SL	02/20/19
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 06SP17, GE0805C-1, TB-1043+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-560	A

FILE:	SCALE:	SHEET:
98PL560	15:1	1 OF 1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A